

LEXANT™ FR RESINS 915R

REGION ASIA

DESCRIPTION

LEXANT™ 915R resin is a 18 MFR polycarbonate, MVR of 18. Mold release. Non-chlorinated, non-brominated flame retardant, UL94 V0 rated. Available in opaque colors.

INDUSTRY	SUB INDUSTRY
Automotive	Automotive Exteriors, Aerospace
Building and Construction	Construction
Consumer	Home Appliances, Personal Recreation, Recreational Vehicle
Electrical and Electronics	Electrical Devices and Displays, Lighting, Electrical Components and Infrastructure
Hygiene and Healthcare	Patient Testing
Mass Transportation	Specialty Vehicles, Rail

TYPICAL PROPERTY VALUES

Revision 20260508

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Tensile Stress, yld, Type I, 50 mm/min	63	MPa	ASTM D638
Tensile Stress, brk, Type I, 50 mm/min	62	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	6	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	130	%	ASTM D638
Tensile Modulus, 50 mm/min	2400	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	93	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2460	MPa	ASTM D790
Hardness, Rockwell M	70	-	ASTM D785
Hardness, Rockwell R	118	-	ASTM D785
IMPACT			
Izod Impact, notched, 23°C	747	J/m	ASTM D256
Instrumented Dart Impact Total Energy, 23°C	67	J	ASTM D3763
Izod Impact, unnotched, 23°C	NB	J/m	ASTM D4812
THERMAL			
Vicat Softening Temp, Rate B/50	138	°C	ASTM D1525
HDT, 0.45 MPa, 3.2 mm, unannealed	132	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	123	°C	ASTM D648
CTE, -40°C to 40°C, flow	7.38E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	7.02E-05	1/°C	ASTM E831
Thermal Conductivity	0.2	W/m-°C	ASTM C177
Specific Heat	1.25	J/g-°C	ASTM C351
Relative Temp Index, Elec	130	°C	UL 746B
Relative Temp Index, Mech w/impact	120	°C	UL 746B
Relative Temp Index, Mech w/o impact	125	°C	UL 746B
PHYSICAL			

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CHEMISTRY THAT MATTERS™



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Specific Gravity	1.2	-	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.15	%	ASTM D570
Water Absorption, (23°C/24hrs)	0.15	%	ASTM D570
Water Absorption, (23°C/Saturated)	0.35	%	ASTM D570
Mold Shrinkage, flow, 3.2 mm	0.6 – 0.8	%	SABIC method
Melt Flow Rate, 300°C/1.2 kgf	18	g/10 min	ASTM D1238
ELECTRICAL			
Arc Resistance, Tungsten {PLC}	7	PLC Code	ASTM D495
Hot Wire Ignition {PLC}	2	PLC Code	UL 746A
High Voltage Arc Track Rate {PLC}	0	PLC Code	UL 746A
High Ampere Arc Ign, surface {PLC}	1	PLC Code	UL 746A
Comparative Tracking Index (UL) {PLC}	3	PLC Code	UL 746A
FLAME CHARACTERISTICS			
UL Yellow Card Link	E207780-228400	-	-
UL Recognized, 94V-0 Flame Class Rating	1.1	mm	UL 94
Glow Wire Flammability Index 850°C, passes at	1	mm	IEC 60695-2-12
Glow Wire Flammability Index 960°C, passes at	1.6	mm	IEC 60695-2-12
Glow Wire Ignitability Temperature, 0.8 mm	800	°C	IEC 60695-2-13
INJECTION MOLDING			
Drying Temperature	120	°C	
Drying Time	3 – 4	Hrs	
Drying Time (Cumulative)	48	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	290 – 310	°C	
Nozzle Temperature	280 – 305	°C	
Front - Zone 3 Temperature	290 – 310	°C	
Middle - Zone 2 Temperature	275 – 300	°C	
Rear - Zone 1 Temperature	265 – 290	°C	
Mold Temperature	70 – 95	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	40 – 70	rpm	
Shot to Cylinder Size	40 – 60	%	
Vent Depth	0.025 – 0.076	mm	

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